

Enhanced ultrafast power diode

Product data sheet

1. General description

Enhanced ultrafast power diode in a SOT428 (DPAK) plastic package.

2. Features and benefits

- High thermal cycling performance
- Low on-state losses
- Low thermal resistance •
- Soft recovery characteristic •
- Surface-mountable package

3. Applications

- Dual Mode (DCM and CCM) PFC •
- Power Factor Correction (PFC) for Interleaved Topology •

4. Quick reference data

Table 1. Qui	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _R	reverse voltage	DC	-	-	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 121 °C; SQW; <u>Fig. 1</u> ; Fig. 2	-	-	5	A
I _{FSM}	non-repetitive peak	t _p = 10 ms; T _{j(init)} = 25 °C; SIN; <u>Fig. 3</u>	-	-	60	А
	forward current	t _p = 8.3 ms; T _{j(init)} = 25 °C; SIN	-	-	66	А
Static chara	acteristics					
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.3	1.9	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.1	1.7	V
Dynamic ch	naracteristics					
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; \text{ V}_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A}/\mu\text{s}; \\ T_j = 25 \text{ °C}; \text{ Fig. 6}$	-	17.5	35	ns

5. Pinning information

Table 2. I	Pinning inf	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected	[]	K – K – A
2	К	cathode[1]		001aaa020
3	А	anode		
mb	К	mounting base; cathode	DPAK (SOT428)	

[1] It is not possible to connect to pin 2 of the SOT428 package.

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
BYV25FD-600	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	SOT428			

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	600	V
V _{RWM}	crest working reverse voltage		-	600	V
V _R	reverse voltage	DC	-	600	V
I _{F(AV)}	average forward current	$\delta = 0.5$; T _{mb} ≤ 121 °C; SQW; <u>Fig. 1</u> ; Fig. 2	-	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 121 °C; SQW	-	10	A
I _{FSM}	non-repetitive peak	t _p = 10 ms; T _{j(init)} = 25 °C; SIN; <u>Fig. 3</u>	-	60	А
	forward current	t _p = 8.3 ms; T _{j(init)} = 25 °C; SIN	-	66	А
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C

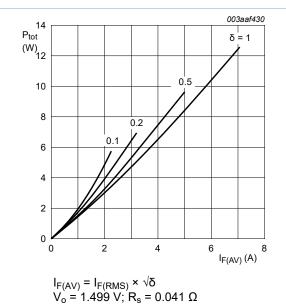
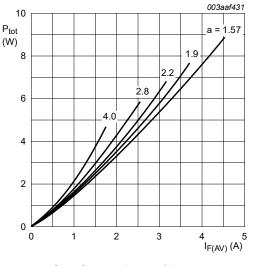


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



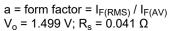
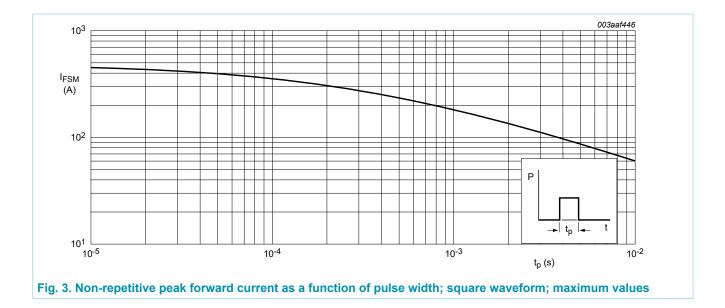


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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Enhanced ultrafast power diode

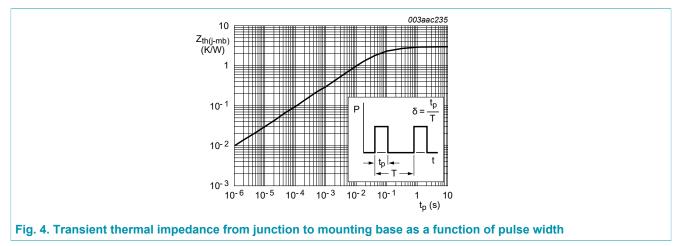


Enhanced ultrafast power diode

8. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	-	3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	[1]	-	50	-	K/W

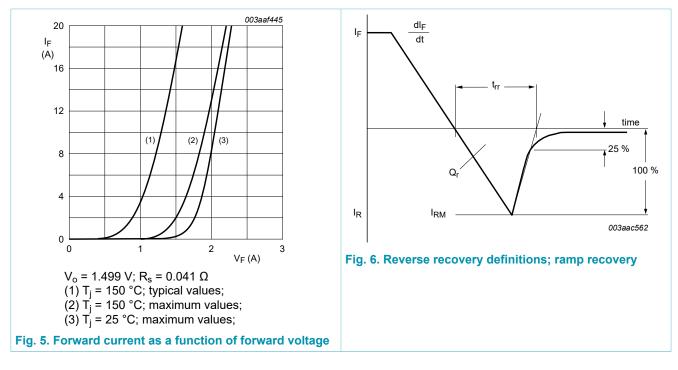
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



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9. Characteristics

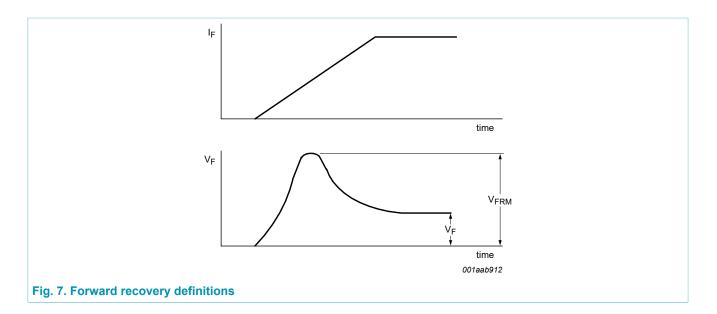
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics	· · · · ·				
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.3	1.9	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.1	1.7	V
I _R	reverse current	V _R = 600 V; T _j = 100 °C	-	-	1.5	mA
		V _R = 600 V; T _j = 25 °C	-	-	50	μA
Dynamic ch	naracteristics	· · · · ·				
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs;	-	17.5	35	ns
I _{RM}	peak reverse recovery current	T _j = 25 °C; <u>Fig. 6</u>	-	1.5	-	A
Q _r	recovered charge		-	13	-	nC
V _{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 100 A/μs; T _j = 25 °C; Fig. 7	-	3.2	-	V



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Enhanced ultrafast power diode



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10. Package outline

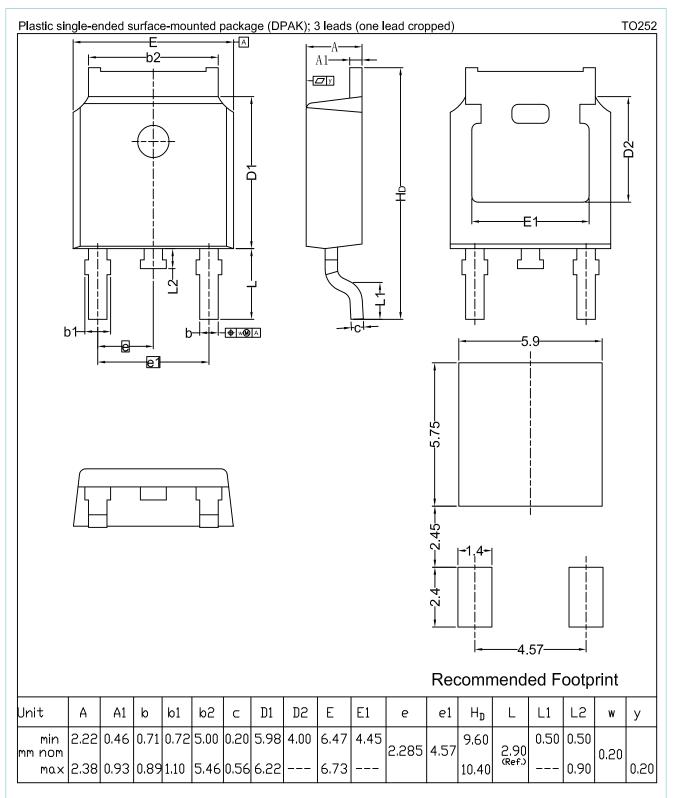


Fig. 8. Package outline DPAK (SOT428)

Enhanced ultrafast power diode

11. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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Enhanced ultrafast power diode

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Enhanced ultrafast power diode

12. Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Limiting values	3
8.	Thermal characteristics	5
9.	Characteristics	6
10	. Package outline	8
11.	. Legal information	9

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